HALOGEN

FREE



Vishay General Semiconductor

Surface Mount Schottky Barrier Rectifier



ט	U-2	219	AB	(5)	MI-

PRIMARY CHARACTERISTICS				
I _{F(AV)}	1.0 A			
V _{RRM}	30 V			
I _{FSM}	40 A			
V _F at I _F = 1.0 A (T _A = 125 °C)	0.31 V			
T _J max.	150 °C			
Package	DO-219AB (SMF)			
Diode variations	Single die			

FEATURES

- Low profile package
- Ideal for automated placement
- · Low forward voltage drop, low power losses
- Low leakage current
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- Wave and reflow solderable
- AEC-Q101 qualified available
 - Automotive ordering code: base P/NHM3
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

TYPICAL APPLICATIONS

For use in high frequency inverters, freewheeling, DC/DC converters, and polarity protection in commercial, industrial, and automotive applications.

MECHANICAL DATA

Case: DO-219AB (SMF)

Molding compound meets UL 94 V-0 flammability rating

Base P/N-M3 - halogen-free, RoHS-compliant

Base P/NHM3 - halogen-free, RoHS-compliant, and

AEC-Q101 qualified

Terminals: Matte tin plated leads, solderable per

J-STD-002 and JESD 22-B102

M3 and HM3 suffix meets JESD 201 class 2 whisker test

Polarity: Color band denotes the cathode end

MAXIMUM RATINGS (T _A = 25 °C unless otherwise noted)					
PARAMETER	SYMBOL	SS1FL3	UNIT		
Device marking code		1L3			
Maximum repetitive peak reverse voltage	V_{RRM}	30	V		
Maximum average forward rectified current (fig. 1)	I _{F(AV)} (1)	1.0	Α		
Non-repetitive peak forward surge current 8.3 ms single half sine-wave at $T_{J\ (init)}=25\ ^{\circ}C$	I _{FSM}	40	А		
Operating junction and storage temperature range	T _J , T _{STG}	-55 to +150	°C		

Note

(1) Free air, mounted on recommended copper pad area



ELECTRICAL CHARACTERISTICS (T _A = 25 °C unless otherwise noted)						
PARAMETER	TEST CONDITIONS		SYMBOL	TYP.	MAX.	UNIT
Instantaneous forward voltage	$I_F = 0.5 A$	T _A = 25 °C	- V _F ⁽¹⁾	0.38	-	- V
	I _F = 1.0 A			0.42	0.48	
	I _F = 0.5 A	T _A = 125 °C		0.26	-	
	I _F = 1.0 A			0.31	0.35	
Reverse current	V 20 V	T _A = 25 °C	1 (2)	-	200	μA
	$V_{R} = 30 \text{ V}$ $T_{A} = 125 \text{ °C}$	T _A = 125 °C	I _R ⁽²⁾	6	12	mA
Typical junction capacitance	nce 4.0 V, 1 MHz		CJ	130	-	pF

Notes

 $^{(1)}\,$ Pulse test: 300 μs pulse width, 1 % duty cycle

(2) Pulse test: Pulse width $\leq 5 \text{ ms}$

THERMAL CHARACTERISTICS (T _A = 25 °c unless otherwise noted)				
PARAMETER	SYMBOL	SS1FL3	UNIT	
Typical they was lyacistance	R ₀ JA (1)(2)(3)	125	°C/W	
Typical thermal resistance	R _{0JM} (2)(3)	22	G/VV	

Notes

 $^{(1)}$ The heat generated must be less than the thermal conductivity from junction-to-ambient: $dP_D/dT_J < 1/R_{\theta JA}$

(2) Device mounted on FR4 PCB, 2 oz. standard footprint

 $^{(3)}$ Thermal resistance $R_{\theta JA}$ - junction to ambient; $R_{\theta JM}$ - junction to mount

ORDERING INFORMATION (Example)					
PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE	
SS1FL3-M3/H	0.015	Н	3000	7" diameter plastic tape and reel	
SS1FL3-M3/I	0.015	I	10 000	13" diameter plastic tape and reel	
SS1FL3HM3/H (1)	0.015	Н	3000	7" diameter plastic tape and reel	
SS1FL3HM3/I (1)	0.015	I	10 000	13" diameter plastic tape and reel	

Note

(1) AEC-Q101 qualified



RATINGS AND CHARACTERISTICS CURVES (T_A = 25 °C unless otherwise noted)

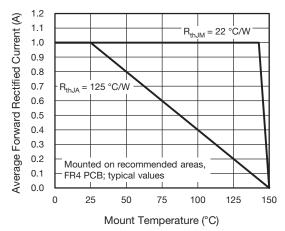


Fig. 1 - Typical Forward Current Derating Curve

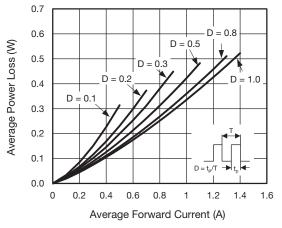


Fig. 2 - Forward Power Loss Characteristics

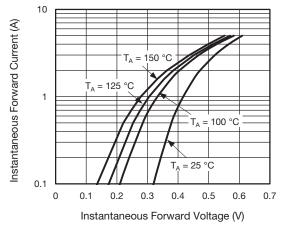


Fig. 3 - Typical Instantaneous Forward Characteristics

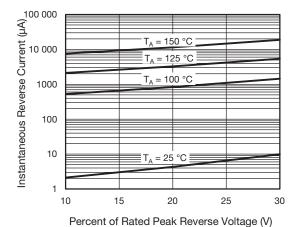


Fig. 4 - Typical Reverse Leakage Characteristics

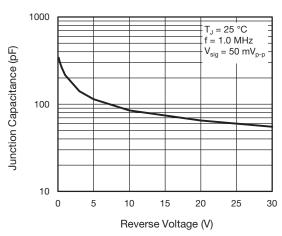


Fig. 5 - Typical Junction Capacitance

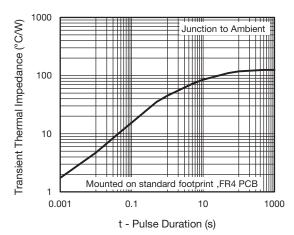
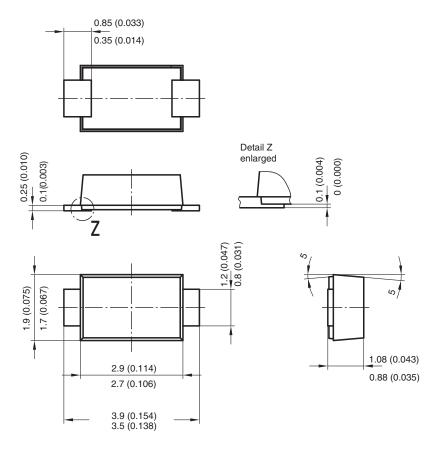


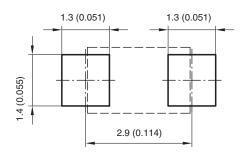
Fig. 6 - Typical Transient Thermal Impedance



PACKAGE OUTLINE DIMENSIONS in millimeters (inches)



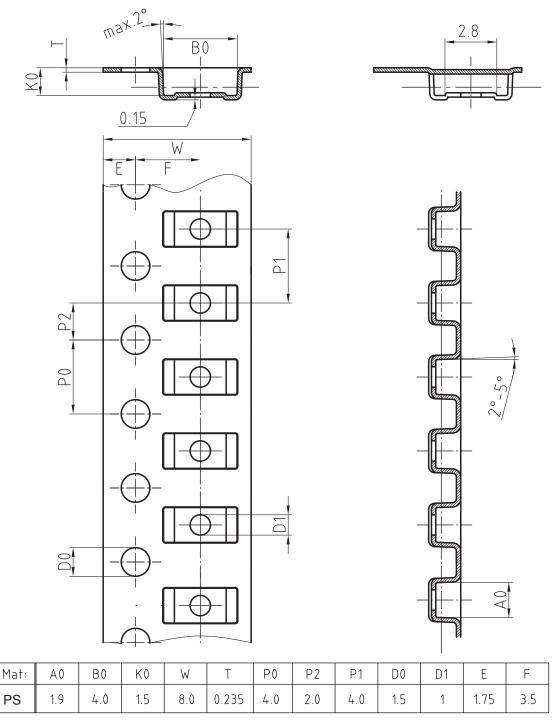
Foot print recommendation:



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BLISTERTAPE DIMENSIONS in millimeters: **DO-219AB (SMF)**



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